

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
FUJITSU SEMICONDUCTOR LIMITED	07/27/2018
RECEIVING PARTY DATA	
Name:	KABUSHIKI KAISHA TOSHIBA
Street Address:	1-1, SHIBAURA 1-CHOME, MINATO-KU
City:	TOKYO
State/Country:	JAPAN
Name:	WINBOND ELECTRONICS CORP.
Street Address:	NO. 4, CREATION RD., III, SCIENCE-BASED INDUSTRIAL PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	10073314
CORRESPONDENCE DATA	
Fax Number:	(571)395-8753
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	patentmail@whda.com
Correspondent Name:	WESTERMAN, HATTORI, DANIELS & ADRIAN, LLP
Address Line 1:	8500 LEESBURG PIKE
Address Line 4:	TYSONS, VIRGINIA 22182
ATTORNEY DOCKET NUMBER:	020171
NAME OF SUBMITTER:	MICHAEL J. CARIDI
SIGNATURE:	/Michael J. Caridi/
DATE SIGNED:	09/10/2018
Total Attachments: 2	
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ASSIGNMENT

WHEREAS,

- 1) **FUJITSU SEMICONDUCTOR LIMITED**, a corporation duly organized under the laws of Japan and having its principal place of business at **2-100-45 Shin-Yokohama, Kohoku-ku, Yokohama-shi, Kanagawa, 222-0033, Japan**
- 2) **KABUSHIKI KAISHA TOSHIBA** a corporation duly organized under the laws of Japan and having its principal place of business at **1-1, Shibaura 1-chome, Minato-ku, Tokyo, Japan**
- 3) **WINBOND ELECTRONICS CORP.** a corporation duly organized under the laws of Japan and having its principal place of business at **No. 4, Creation Rd., III, Science-based Industrial Park Hsinchu 300, Taiwan R.O.C.**

are the owners of the entire right, title and interest in the invention entitled "ALIGNMENT SENSING METHOD FOR SEMICONDUCTOR DEVICE", which is described and claimed in U.S. Patent No. 7,586,202, by virtue of an assignment recorded at the U.S. Patent and Trademark Office on July 9, 2010, at Reel 024651, Frame 0744;

WHEREAS, **FUJITSU SEMICONDUCTOR LIMITED**, hereinafter referred to as ASSIGNOR, is desirous of assigning its entire right, title and interest to said U.S. Patent;

WHEREAS, **KABUSHIKI KAISHA TOSHIBA** and **WINBOND ELECTRONICS CORP.**, a corporation duly organized under the laws of Japan and having its principal place of business at **1-1, Shibaura 1-chome, Minato-ku, Tokyo, Japan** and **No. 4, Creation Rd., III, Science-based Industrial Park Hsinchu 300, Taiwan R.O.C.**, hereinafter referred to as ASSIGNEES, is desirous of acquiring the entire right, title and interest as held by ASSIGNOR in, to and under the said U.S. Patent;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: be it known that for good and valuable consideration, the adequacy and receipt of which is hereby acknowledged by, ASSIGNOR hereby sells, assigns, and transfers to ASSIGNEE, its entire right, title, and interest in and to United States Patent No. 7,586,202 and the inventions therein, for the full term of the

said United States Patent and any and all U.S. patents granted therein and any reissue, extension, reexamination, continuation, or divisional thereof.

IN WITNESS WHEREOF, the undersigned ASSIGNOR has hereunto set hand and seal
this 27th day of July, 2018.

Assignor: FUJITSU SEMICONDUCTOR LIMITED

Signature

of Representative:



Name: Keisuke Ishiwata

Title: Director, Intellectual Property Dept. Legal and Intellectual Property Div.

Corporate Management Unit